Dual PNP Transistors

General Purpose PNP Transistor and PNP Transistor with Monolithic Bias Network

NSM11156DW6T1G contains a single PNP transistor and a monolithic bias network PNP transistor with two resistors; a series base resistor and a base-emitter resistor. This device is designed to replace multiple transistors and resistors on customer boards by integrating these components into a single device. NSM11156DW6T1G is housed in a SC-88/SOT-363 package which is ideal for low power surface mount applications in space constrained applications.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Q1: PNP BRT, R1 = R2 = 10 k
- Q2: PNP
- This is a Pb-Free Device

Applications

- Logic Switching
- Amplification
- Driver Circuits
- Interface Circuits

MAXIMUM RATINGS

(T_A = 25°C unless otherwise noted)

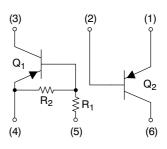
Rating - Q1 (PNP BRT)	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-50	Vdc
Collector-Emitter Voltage	V_{CEO}	-50	Vdc
Collector Current	Ic	-100	mAdc
Rating - Q2 (PNP)	Symbol	Value	Unit
Collector - Base Voltage	V _{(BR)CBO}	-80	Vdc
Collector - Emitter Voltage	V _{(BR)CEO}	-65	Vdc
Emitter - Base Voltage	V _{(BR)EBO}	-5.0	Vdc
Collector Current - Continuous	I _C	-100	mAdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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SC-88/SOT-363 CASE 419B STYLE 1

MARKING DIAGRAM



N6 = Device Code M = Date Code* • Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NSM11156DW6T1G	SC-88 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation	P _D		
$T_A = 25^{\circ}C$		180 (Note 1)	mW
Derate above 25°C		1.44 (Note 1)	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	692 (Note 1)	°C/W
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation,	P_{D}		
$T_A = 25^{\circ}C$		230	mW
Derate above 25°C		1.83	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	544	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

^{1.} FR-4 @ Minimum Pad of 1.45 mm², 1 oz Cu.

ELECTRICAL CHARACTERISTICS – Q1 (PNP BRT) ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit		
OFF CHARACTERISTICS							
Collector-Base Cutoff Current (V _{CB} = -50 V, I _E = 0)	Ісво	-	-	-100	nAdc		
Collector-Emitter Cutoff Current (V _{CE} = -50 V, I _B = 0)	I _{CEO}	-	-	-500	nAdc		
Emitter-Base Cutoff Current $(V_{EB} = -6.0 \text{ V}, I_C = 0)$	I _{EBO}	-	-	-0.5	mAdc		
Collector-Base Breakdown Voltage (I _C = -10 μA, I _E = 0)	V _{(BR)CBO}	-50	-	-	Vdc		
Collector-Emitter Breakdown Voltage (Note 2) $(I_C = -2.0 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	-50	-	-	Vdc		
ON CHARACTERISTICS (Note 2)							
DC Current Gain $(V_{CE} = -10 \text{ V}, I_{C} = -5.0 \text{ mA})$	h _{FE}	35	60	-			
Collector-Emitter Saturation Voltage (I _C = -10 mA, I _B = -0.3 mA)	V _{CE(sat)}	-	-	-0.25	Vdc		
Output Voltage (on) $(V_{CC} = -5.0 \text{ V}, V_B = -2.5 \text{ V}, R_L = 1.0 \text{ k}\Omega)$	V _{OL}	-	-	-0.2	Vdc		
Output Voltage (off) $(V_{CC} = -5.0 \text{ V}, V_B = -0.5 \text{ V}, R_L = 1.0 \text{ k}\Omega)$	V _{OH}	-4.9	-	-	Vdc		
Input Resistor	R1	7.0	10	13	kΩ		
Resistor Ratio	R1/R2	0.8	1.0	1.2			

^{2.} Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

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ELECTRICAL CHARACTERISTICS - Q2 (PNP) (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•			
Collector - Emitter Breakdown Voltage (I _C = -10 mA)	V _{(BR)CEO}	-65	-	-	V
Collector - Emitter Breakdown Voltage (I _C = -10 μA, V _{EB} = 0)	V _{(BR)CES}	-80	-	-	V
Collector – Base Breakdown Voltage $(I_C = -10 \mu A)$	V _{(BR)CBO}	-80	-	-	V
Emitter – Base Breakdown Voltage $(I_E = -1.0 \mu A)$	V _{(BR)EBO}	-5.0	-	-	V
Collector Cutoff Current ($V_{CB} = -30 \text{ V}$) ($V_{CB} = -30 \text{ V}$, $T_A = 150 ^{\circ}\text{C}$)	Ісво		- -	-15 -4.0	nA μA
ON CHARACTERISTICS					
DC Current Gain $ (I_C = -10 ~\mu\text{A}, ~V_{CE} = -5.0 ~\text{V}) $ $ (I_C = -2.0 ~\text{mA}, ~V_{CE} = -5.0 ~\text{V}) $	h _{FE}	- 220	150 290	- 475	-
Collector - Emitter Saturation Voltage ($I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA}$) ($I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA}$)	V _{CE(sat)}	- -	- -	-0.3 -0.65	V
Base – Emitter Saturation Voltage $(I_C = -10 \text{ mA}, I_B = -0.5 \text{ mA})$ $(I_C = -100 \text{ mA}, I_B = -5.0 \text{ mA})$	V _{BE(sat)}	- -	-0.7 -0.9	-	٧
Base – Emitter On Voltage ($I_C = -2.0$ mA, $V_{CE} = -5.0$ V) ($I_C = -10$ mA, $V_{CE} = -5.0$ V)	V _{BE(on)}	-0.6 -	-	-0.75 -0.82	٧

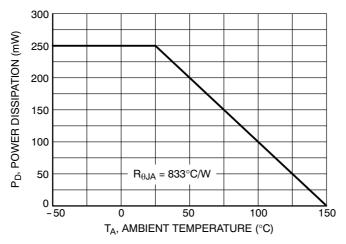
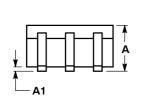
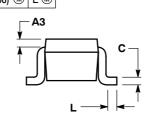


Figure 1. Derating Curve

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PACKAGE DIMENSIONS





NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
 V14 5M 1992
- Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
- 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

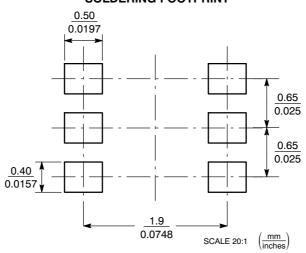
	MIL	MILLIMETERS INCH			INCHES	3
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3		0.20 RE	F	0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
С	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
е	(0.65 BSC		0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086

STYLE 1:

PIN 1. EMITTER 2

- 2. BASE 2 3. COLLECTOR 1
- COLLECTOR
 EMITTER 1
- 5 BASE 1
- BASE 1
 COLLECTOR 2

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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